# A nisotropic $m$ agnetoresistance contribution to $m$ easured dom ain wall resistances of in-plane $m$ agnetised ( Ga a,M n)A s 

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#### Abstract

W e dem onstrate the presence of an im portant anisotropic m agnetoresistance contribution to the dom ain wall resistance recently $m$ easured in thin- $m$ ( $G a_{,} M n$ )A $s w$ ith in-planem agnetic anisotropy. A nalytic results for sim ple dom ain wall orientations supplem ented by num erical results for m ore general cases show this previously om itted contribution can largely explain the observed negative resistance.


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The electrical resistance associated with current ow across a dom ain wall (D W ) separating unifom ly magnetised regions in a $m$ agnetic $m$ aterial has been the sub ject of investigation since the 1930s. A large volum e of of ten contradictory results exists, m ostly attributable to the di culty in separating norm ally sm all intrinsic effects from the $m$ yriad of extrinsic e ects that also contribute in $m$ agnetoresistance $m$ easurem ents. In recent years som e consensus has em erged in the study of DW $s$ in $m$ etallic epitaxial $\mathrm{m} s$ and nanostructures ${ }^{2}$ where it is possible to more fully characterise and control the m agnetic m icrostructure, w ith m any results consistent w ith the spin m istracking m odels of $\mathrm{D} W$ resistance, 3,4 A though the sm allm agnitude of the D W resistance lim its potential applications, signi cant enhancem ents at nanoconstrictions ${ }^{5}$ allied w ith advances in the atom icscale control of $m$ aterials, raise hopes of practicalm agnetoresistive devices, whilst a close relationship with the phenom enon of current-induced $D W \mathrm{~m}$ otion ${ }^{6,7}$ also $m$ akes the understanding of $D W$ resistance of consider$a b l e$ im portance.

It has been noted that enhanced $m$ agnetoresistance $e$ ects $m$ ay be associated $w$ th DW $s$ in ferrom agnetic sem iconductors due to the longer Ferm iw avelength ${ }^{6}$ and large exchange splitting relative to band width $\frac{8}{-}$ R uster et al. have observed an $8 \%$ increase in the $m$ agnetoresistance due to DW s pinned at < 10 nm constrictions in in-plane $m$ agnetised ( $\mathrm{G} a, \mathrm{M} n$ )A $s$ nanostructures, and Chiba et al ${ }^{10}$ report a signi cant positive DW magnetoresistance in perpendicularly magnetised ( G a,M n)A s layers consistent w ith the theory of Levy and Zhang. ${ }^{4}$ Tang et al ${ }^{11}$ have studied the resistance of $30 \quad 100 \mathrm{~m}$ devices pattemed from in-plane $m$ agnetised ( $G$ a,M n)A s epilayers. By $m$ easuring the average resistance hR i along the sides of the device channel as a 90 dom ain wall is driven through by current pulses, they nd a sm all resistance drop. Scaling by a wallw idth of $10 \mathrm{~nm}, \mathrm{~T}$ ang et al. deduce a DW resistivity as large as \%= $100 \%$ a rem arkable result im plying resistance free current transport through the region occupied by the DW. A though theories exist that predict a negative intrinsic $D W$ resistance, either as a result ofm odi cations to quantum interference phenom ena ${ }^{12}$ or di erences in spin-dependent relaxation rates, ${ }^{13}$ this result is $m$ any orders of $m$ agni-
tude greater than any negative DW resistivity previously reported in a m etall

In this work we dem onstrate the existence of a size-
 $m$ easured using the experim entalcon guration em ployed in $R$ ef. [11]. This anisotropic $m$ agnetoresistance (AM $R$ ) $e$ ect arises from the circulating currents induced by the abrupt change in the o -diagonal resistivity at 90 DW, and persists even after the resistance is averaged across the sample. An analytic expression is derived for the sim plest DW orientation, supplem ented by num erical results for the $m$ ore general case, which also allow us to sim ulate the experim ents where a current-driven $D W$ is m oved through a m icrodevice.

W e consider the current ow w ithin an in nitely long thin conducting sam ple w ith rectangular cross section, w idth $w$, thickness $t$. T he sam ple lies parallel to the xy plane w ith the long edge parallel to the x axis ( F ig. (1). A dcelectricalcurrent I ow sthrough the sam ple. Ideal probes are attached and $m$ easure the potential at points on either side of the sam ple separated by a distance 1.

The current density $J(x ; y)$ is assum ed to be uniform as $\times!1$, and no current ows through the sides of the device:

$$
\begin{align*}
J(1 ; y) & =(I=w t ; 0)=(j ; 0)  \tag{1a}\\
J_{y}(x ; 0) & =J_{y}(x ; w)=0: \tag{1b}
\end{align*}
$$

$W$ ithin the sam ple, $J$ is found by satisfying current continuity and the steady state $M$ axw ell equation, $w$ th the


FIG. 1: The geom etry considered in this work. A dom ain wall inclined at an angle \# separates regions in which the in p lane m agnetisation lies at angles ' 1 and ' 2 . Potential $m$ easurem ents are $m$ ade using probes $A, B, C$ and $D$.
electric eld E and current density related via O hm 's law

$$
\begin{array}{rl}
r & J=0 \\
r & E=0 \\
E=A J \tag{2c}
\end{array}
$$

with ^ a spatially varying resistivity tensor. W ith inplane $m$ agnetised ( $G$ a,M n)A s epilayers, the resistivity in directions parallel (k) and penpendicular ( ? ) to the $m$ agnetisation dier ${ }^{14}$ with ${ }_{k}<$ ?. If' is the $m a g-$ netisation direction in a given dom ain ( $F$ ig. (1), the corresponding cartesian tensor is

$$
\begin{align*}
& \wedge=R,{ }^{1} \quad 0^{k} \quad 0 \quad R, \\
& =\begin{array}{cc}
1+\frac{2}{2} \cos 2^{\prime} & \overline{2} \sin 2^{\prime} \\
\overline{2} \sin 2^{\prime} & 1 \\
\hline 2 \cos 2^{\prime}
\end{array} \tag{3}
\end{align*}
$$

where $=\left(?+{ }_{k}\right)=2, \quad(k \quad$ ? $)=$. W ith cubic anisotropy, dom ain walls divide regions which have m agnetisation directions di ering by 90 , but in the experim ents recently reported this is modi ed by a weak in-plane uniaxial anisotropy. W e denote by \# the angle which the norm alto the wall ( $\hat{r}_{D W}$ ) makes with respect to the x axis. F ig. 1 show s the geom etry in the case of a single dom ain wallw ithin the devige.

At the wall itself, the boundary conditions are continuity in the norm alcom ponent of the current and in the tangential com ponent of the electric eld:

$$
\begin{align*}
& \mathrm{J} ? \hat{n}_{\mathrm{DW}}=\mathrm{J}_{\mathrm{x}} \cos \#+\mathrm{J}_{\mathrm{y}} \sin \#  \tag{4a}\\
& \mathrm{Ek} \hat{\mathrm{n}} \hat{\mathrm{D}}=\mathrm{E}_{\mathrm{x}} \sin \#+\mathrm{E}_{\mathrm{y}} \cos \# \\
& =\left(\circ_{x x} J_{x}+\circ_{x y} J_{y}\right) \sin \# \\
& +\left(\%_{y x} J_{x}+\circ_{y y} J_{y}\right) \cos \#: \tag{4b}
\end{align*}
$$

$M$ atching (4.b) when the resisitivity tensor elem ents are di erent on either side of the DW is not possible w ith a uniform current $J=(j ; 0)$; the $D W$ induces circulating currents and it is these that give rise to an AMR contribution to the resistance across the wall.

To see this, we rst consider the case where the device channel contains a DW in the yz plane (\# = 0) at $\mathrm{x}=\mathrm{x}_{0}$, separating regions in which the in-plane m agnetisation is at an angle ' 1 in region 1 and ' 2 in region 2. T he average of the longitudinal resistances $m$ easured along opposite sides of the device, used in Ref. [11] to elim inate contributions from the planar $H$ all e ect, can be expressed in term s of a di erence in voltages at either end of the device channel:

$$
\begin{align*}
\text { IhR } i & =\left(V_{B} \quad V_{A}\right)=2+\left(V_{D} \quad V_{C}\right)=2 \\
& =\left(V_{B}+V_{D}\right)=2 \quad\left(V_{A}+V_{C}\right)=2: \tag{5}
\end{align*}
$$

(T he $m$ inus sign is because the potential falls along the direction of positive current ow .) W e take the length $l$ (and $x_{0}$ ) to be large enough so that the static eddy currents induced by the DW are fully contained w ith in
the area of the device de ned by the 4 probes, and then the current has its asym ptotic value at both $\mathrm{x}=0$ and $\mathrm{x}=1$. Thism eansthat the electric eld in the y -direction is constant both betw een $C$ and $A, E_{Y}(0 ; y)={ }_{y x}^{1} j$, and $D$ and $B, E_{y}(l ; y)={\underset{y x}{2}}_{2}^{j}$, and the voltage changes linearly betw een points $C$ and $A$, and between D and B. $T$ he voltage averages in (5) can then be re-expressed as integrals of the voltage across the device, e.g.

$$
\begin{equation*}
\left(V_{B}+V_{D}\right)=2=\frac{1}{w}_{0}^{\mathrm{Z}}{ }_{\mathrm{w}}^{\mathrm{w}} \mathrm{~V}(1 ; y) d y ; \tag{6}
\end{equation*}
$$

and the two term $s$ in $_{\mathrm{R}}\left(\frac{51}{(5)}\right.$ then can be combined using $V(1 ; y) \quad V(0 ; y)=\quad{ }_{0}^{R_{1}} E_{x}(x ; y) d x$ to give $h R$ i in term $s$ of an integral of the electric eld over the area of the device betw een the probes:

$$
\begin{equation*}
\operatorname{IhR} i=\frac{1}{w}_{x=0}^{Z^{Z}} Z_{w=0} E_{x}(x ; y) d x d y: \tag{7}
\end{equation*}
$$

Splitting the integral into separate contributions from the two dom ains w ithin each of which the resistivity tensor is constant, and using the follow ing results

$$
Z_{w} J_{x}(x ; y) d y=j w ; \quad Z_{J_{y}}(x ; y) d x=0
$$

that are found by integrating the continuily equation over regions $=f\left(x^{0} ; y\right) 2 R^{2} j 0 \quad x^{0} \quad x ; 0 \quad y \quad w g$ and $=f\left(x ; y^{0}\right) 2 R^{2} j 0 \quad x \quad 1 ; 0 \quad y^{0} \quad y g$ respectively, yields

$$
\begin{align*}
& h R i=\frac{1}{w t}{ }_{x x}^{1} x_{0}+{ }_{x x}^{2}\left(\begin{array}{ll}
x_{0}
\end{array}\right) \tag{9}
\end{align*}
$$

The rst term describes a resistance that linearly interpolates betw een the asym ptotic resistances of the channel in the two uniform $m$ agnetisation states. In Ref. [11] di erences betw een $m$ easured resistance values and this linear interpolation have been interpreted as originating from an intrinsic $D W$ resistivity. H ow ever, the nalterm in (9), which henceforth we denote $R_{A M R}$, is a new contribution that we nd, which results directly from the discontinuity in the resisitivity at the DW and which is proportional to the total parallel current induced on either side of the DW .

To obtain an estim ate for the value of this additional contribution to the D W resistance, we consider the case where ${ }_{1}='_{2}=$ ' which applies when the hard axis is perfectly aligned along the devige channel. Then the diagonal com ponents of the resistivity tensors are continuous across the DW, and the $O$-diagonalcom ponents change sign. For sm all the longitudinal current com ponent $J_{\mathrm{x}} \mathrm{w}$ illbe dom inated by the uniform background current $j$, except $w$ thin a distanœ $w$ of the sides of the device near the DW where the current perturbation is concentrated. Neglecting this edge correction, it then


FIG . 2: C alculated A M R contribution to the resistance across a DW for di erent values of the anisotropy . Symbols, nu$m$ erically calculated values; solid line, values using E qn. (11) . A $m$ thickness $t=100 \mathrm{~nm}$, resistivity $=310^{4} \mathrm{~m}$, m isalignm ent $=0, \mathrm{DW}$ angle \# $=0$ and magnetisation angle' $=45$ have been used. Insets: the e ect of varying the DW angle \# and $m$ isalignm ent .
follow s from Eqn. (4) that im $m$ ediately on either side of the DW

$$
\begin{equation*}
J_{y}\left(x_{0} \quad 0^{+} ; y\right)^{\prime} \quad \frac{j}{2} \sin 2^{\prime}: \tag{10}
\end{equation*}
$$

Ignoring anisotropy, the slow est decay ing current perturbations decay like ${ }^{15} \exp \dot{\mathrm{j}} \mathrm{w}$ and by assum ing that $J_{y}$ decays like this from the interface value (10) we can evaluate the integral in (9) to get for the AM R contribution to the average longitudinal resistance

$$
\begin{equation*}
\mathrm{R}_{\mathrm{AMR}}=\quad \mathrm{R} \frac{2}{2} \sin ^{2} 2^{\prime} \tag{11}
\end{equation*}
$$

$w$ here $R==t$ is the sheet resistance. $T$ his result show $s$ how the circulating currents give rise to a negative contribution to the resistance across the D W .

W e have also perform ed num erical studies of the current distributions and resulting elds and voltages in the presence ofD W s. T he num ericalsolution is not restricted to the speci ccon guration that was assum ed in deriving the analytic estim ate for $R_{A M R}$, so as wellas enabling an assessm ent of the accuracy of this expression obtained we are also able to include the e ects of $m$ isalignm ent of the hard axis $w$ ith respect to the device channel, and the angle of the dom ain wall. Som e results are given in Fig. 2. T . he solution is obtained by introducing a stream function ( $x ; y$ ) that is related to the current density via $J=(@=@ y ; ~ @=@ x)$, thereby ensuring that current continuity Eqn. (2a) is satis ed. C om bining Eqns (2b) and (2d) then results in a non-separable elliptic partial di erential equation ${ }^{16}$ that we solve for via the m ultigrid relaxation m ethod.

In $F$ ig. 3a we show typical results from our num erical studies, displaying the variation in the longitudinal resistance as a DW inclined at an angle \# = 20 passes along a device channel of $w$ idth $w=30 \mathrm{~m}$ and w th voltage


FIG. 3: (a) Variation in average resistance along the sides of the device channel (between $x=0$ and $x=180 \mathrm{~m}$ ) as a function of the position of the DW . The aspect ratio is l=w $=6$ and the DW inclined at \# = 20 . See the text for the other param eters used. T he inset show s the induced current ow . (b) Sim ilar to (a) but for di erent $m$ aterial param eters (see text) and dim ensions: the resistance is m easured betw een $\mathrm{x}=0$ and $\mathrm{x}=200 \mathrm{~m}, \mathrm{l}=\mathrm{w}=2$ and $\#=50$.
probes separated by $l=180 \mathrm{~m}$. The average resistance of the two uniform $m$ agnetisation states has been subtracted: $R_{x x}=h R i \quad\left(\circ_{x x}^{1}+\circ_{x x}^{2}\right) l=(2 w t)$. A general linear variation in the resistance is seen, except w hen the probes are $w$ thin the range of the circulation currents induced by the DW ; these cause a rapid variation over a distance $\mathrm{w} \tan \#+2 \mathrm{w}=$ as expected from geom etrical considerations and the discussion follow ing Eq. (10). Furtherm ore, we see that the calculated resistance lies below a straight line interpolation perform ed betw een the two asym ptotic channel resistances of the two m agnetisation states. In this calculation we use values that correspond as best as possible to the system reported in F ig. 4 ofR ef. [11]: m resistivity $\%=3 \quad 10^{4} \mathrm{~m}$, thickness $t=100 \mathrm{~nm}$, and anisotropy ${ }^{18}=0: 03 . \mathrm{Them}$ agnetisation orientations $w$ thin the two dom ains are taken to be ${ }_{1}=+$; $_{2}=\quad$ where $=37$ due to uniaxialanisotropy ${ }^{14,17}$ and the m isalignm ent $=0.28$ (the di erence betw een the asym ptotic resistances,

$$
\begin{equation*}
\left(\circ_{x x}^{2} \quad \frac{\circ}{\sigma_{x x}}\right) \frac{l}{w t}=\frac{\circ}{w t} \sin 2 \sin 2 ; \tag{12}
\end{equation*}
$$

is then 5 as found in Ref. [11]). U sing these values, num erically we nd the resistance is low ered by $0: 33$ as a result of the eddy currents induced by the DW .

In $F$ ig. 2 we com pare num erical values for $R_{A M R}$ found in a num ber ofsim ilar calculations to that just described, w ith those obtained using Eqn. (11). The num erical results also display the ${ }^{2}$ dependence and, as expected
given the approxim ationsm ade in estim ating the current integral, our analytic expression overestim ates the actual resistance, we nd by approxim ately $15 \%$ when $\#=0$. $T$ his value of $R_{A M R}$ is further reduced at $D W$ inclined relative to the current direction, but is relatively insensitive to the m isalignm ent angle (insets in F ig. (2). T hus Eqn. (11) has som e value in estim ating the AM R contribution to the DW resistance, but num erical calculations are required for accurate estim ates.

In Fig. 30 we show the calculated longitudinal resistance for a second case, w ith param eters chosen to correspond to the device reported in $F$ ig. 1 in $R$ ef. [11]. This was the initial devige studied experim entally, in which the $m$ isalignm ent of the hard axis $w$ ith the device channel is greater. We use \% = $410^{4} \mathrm{~m}, \mathrm{t}=150 \mathrm{~nm}$,
$=0: 03, \mathrm{w}$ th the channel w idth $\mathrm{w}=100 \mathrm{~m}$ and voltage probes separated by 200 m . A lso, $=37$,
$=1: 5$. The greater structure exhibited by $R_{\mathrm{xx}}$ in this case is due to a larger DW inclination (\# = 50) and the sm aller aspect ratio $\mathrm{l=w}$ of the device, and results in a linear variation over only a short range ofD $W$ positions $m$ idw ay betw een the voltage probes. The precise results are rather sensitive to the value of\#. H ow ever, generally we nd that in the linear region the large spatial extent of the eddy currents still a ects the slope of the resistance curve, which no longer coincides w ith a linear interpolation of the asym ptotic resistances betw een the probe positions. T he dashed line in $F$ ig. 3b which is parallel to the linear section of the resistance curve connects points som e $30 \%$ further apart than the probes. T he calculated resistance is again low ered due to the AM R, but the difference of $0: 16$ is sm aller than the value ( $0: 18$ ) found if the distance betw een the voltage probes is increased so as to fully contain the eddy currents.

The magnetisation pro le within the wall can also give rise to a negative AMR. However, the contribu-
tion we describe above dom inates here. A ssum ing a 90 N eel like wall with m agnetisation rotating like $(\mathrm{x})=$ ( $1=2$ ) $\tan ^{1} \sinh x=$, where is the wallw idth, gives a contribution to leading order of $=(2 \mathrm{w}) \mathrm{R}_{A_{M R}}$, or just a few percent of the contribution from the circulation currents. O ther wall pro les in which the spin rotates out of the plane lead to the sam e conclusion. O nly if the DW $s$ in this system were 180 walls would the inw allcontribution be signi cant, since then the circulation current contribution (11) vanishes.

C om paring w ith experim ent, the DW resistances reported in [11] for the devioes $m$ odelled in $F$ igs $3 a$ and $3 b$ are 1:0 0:2 and 0:44 0:5 respectively; a third set of devices sim ilar to that of $F$ ig. 3 B but $w$ ith $w=60 \mathrm{~m}$ gave $0: 3 \quad 0: 2$. The corresponding $R_{A M R}$ values we nd are 0:33 , 0:16 and 0:33. The previously neglected AM R contributions to the resistance across the DW make a major contribution to, and can largely explain, the negative values observed, w th the exception of one set of devices where a true negative intrinsic $D W$ resistance $m$ ay indeed have been observed. C learly further experim ents are required to clarify the situation, before attem pts to quantitatively account for the DW resistance ${ }^{19}$ can be properly assessed. For these, devioes w ith a large aspect ratio $l=w$, and containing D W s orientated norm alto the device channel, are clearly desirable.

To summarise, we have identi ed a signi cant anisotropic $m$ agnetoresistance contribution to the negative dom ain wall resistivities recently observed in m icrodevices fabricated from ( $\mathrm{G} \mathrm{a}_{\mathrm{M}} \mathrm{M}$ n)A s epilayers. W e derive an analytic estim ate of the $m$ agtitude of this contribution, and report calculations of the channel resistance as a DW is moved through the device which provide a good description of the experim ents.

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